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TECHNOLOGY CENTER 1700

UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Paul MARIAGGI et al.

Examiner: Travis B. Ribar

Serial No.: 09/778,880

Group Art Unit: 1711

Filed: February 8, 2001

Title: EXPANDABLE AND CURABLE FLEXIBLE PREFORM CONTAINING
UNSATURATED RESINS, FOR CASING A WELL OR A LINE

SUPPLEMENTAL AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

Further to the Reply mailed July 5, 2002, please amend the above identified application
as follows.

IN THE CLAIMS:

Please add new claims 30-34 as follows.

Sub D1
cont.
BT
CMT

--30. A radially deployable flexible preform to form, after deploying, a tubular structure that is curable by polymerization after positioning it in a well or in a line and moulds to the shape thereof after curing, comprising in its constitution at least one resin of an unsaturated polyester resin or a vinylester resin comprising in its chemical formula at least one reactive multiple bond that has a dynamic viscosity of less than about 2500 mPa.s at a temperature of about 20°C to about 70°C, and is capable of subsequent reaction with compounds comprising in their constitution at least one terminal reactive multiple bond or a reactive multiple bond positioned at one end or the other of the molecular chain and/or on a pendant group and is selected from the